CMOS ASYNCHRONOUS FIFO 256 x 9, 512 x 9, 1,024 x 9

IDT7200L IDT7201LA IDT7202LA

FEATURES:

- First-In/First-Out dual-port memory
- 256 x 9 organization (IDT7200)
- 512 x 9 organization (IDT7201)
- 1,024 x 9 organization (IDT7202)
- Low power consumption
 - Active: 770mW (max.)
 - -Power-down: 2.75mW (max.)
- Ultra high speed—12ns access time
- · Asynchronous and simultaneous read and write
- Fully expandable by both word depth and/or bit width
- Pin and functionally compatible with 720X family
- Status Flags: Empty, Half-Full, Full
- Auto-retransmit capability
- High-performance CEMOSTM technology
- Military product compliant to MIL-STD-883, Class B
- Standard Military Drawing #5962-87531, 5962-89666, 5962-89863 and 5962-89536 are listed on this function
- Industrial temperature range (-40°C to +85°C) is available (plastic packages only)

DESCRIPTION:

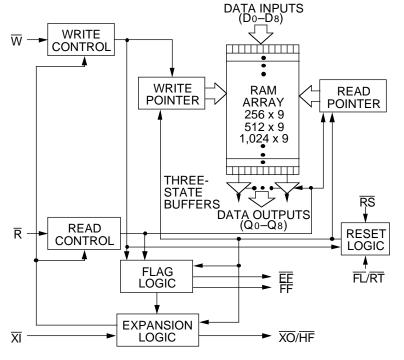
The IDT7200/7201/7202 are dual-port memories that load and empty data on a first-in/first-out basis. The devices use Full and Empty flags to prevent data overflow and underflow and expansion logic to allow for unlimited expansion capability in both word size and depth.

The reads and writes are internally sequential through the use of ring pointers, with no address information required to load and unload data. Data is toggled in and out of the devices through the use of the Write (\overline{W}) and Read (\overline{R}) pins.

The devices utilize a 9-bit wide data array to allow for control and parity bits at the user's option. This feature is especially useful in data communications applications where it is necessary to use a parity bit for transmission/reception error checking. It also features a Retransmit (\overline{RT}) capability that allows for reset of the read pointer to its initial position when \overline{RT} is pulsed low to allow for retransmission from the beginning of data. A Half-Full Flag is available in the single device mode and width expansion modes.

These FIFOs are fabricated using IDT's high-speed CMOS technology. They are designed for those applications requiring asynchronous and simultaneous read/writes in multiprocessing and rate buffer applications. Military grade product is manufactured in compliance with the latest revision of MIL-STD-883, Class B.

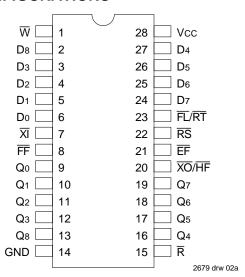
FUNCTIONAL BLOCK DIAGRAM



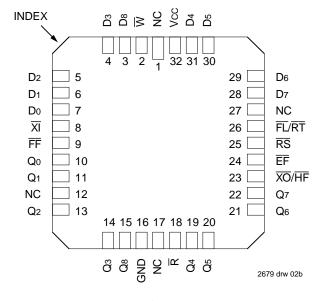
The IDT logo is a trademark of Integrated Device Technology, Inc.

2679 drw 01

PIN CONFIGURATIONS



	Reference	Order
	<u>Identifier</u>	Code
PLASTIC DIP ⁽¹⁾	P28-1	Р
PLASTIC THIN DIP	P28-2	TP
CERDIP ⁽¹⁾	D28-1	D
THIN CERDIP	D28-3	TD
SOIC	SO28-3	SO
CERPAK ⁽¹⁾	E28-2	ΧE



	Reference	Order
	<u>Identifier</u>	<u>Code</u>
LCC ⁽¹⁾	L32- 1	L
PLCC	J32-1	J
	TOP VIEW	

TOP VIEW

NOTE:

1. The 600-mil-wide DIP (P28-1 and D28-1), CERPACK and LCC are not available for the 7200.

ABSOLUTE MAXIMUM RATINGS

Symbol	Rating	Com'l & Ind'l	Mil.	Unit
VTERM	Terminal Voltage with Respect to GND	-0.5 to +7.0	-0.5 to +7.0	٧
Tstg	Storage Temperature	-55 to +125	-65 to +155	°C
lout	DC Output Current	-50 to +50	-50 to +50	mA

NOTE: 2679 tbl 01

CAPACITANCE ($TA = +25^{\circ}C$, f = 1.0 MHz)

Symbol	Parameter ⁽¹⁾	Condition	Max.	Unit
CIN	Input Capacitance	VIN = 0V	8	pF
Соит	Output Capacitance	Vout = 0V	8	pF

NOTE:

1. This parameter is sampled and not 100% tested.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min.	Тур.	Max.	Unit
VCCM	Military Supply Voltage	4.5	5.0	5.5	V
VCCC	Commercial Supply Voltage	4.5	5.0	5.5	V
GND	Supply Voltage	0	0	0	V
VIH ⁽¹⁾	Input High Voltage Commercial	2.0	1		V
VIH ⁽¹⁾	Input High Voltage Military	2.2	_	_	V
VIL ⁽²⁾	Input Low Voltage Commercial and Military	1		0.8	V
ТА	Operating Temperature Commercial	0	1	70	°C
ТА	Operating Temperature Industrial	-40	_	85	°C
ТА	Operating Temperature Military	- 55	_	125	°C

NOTES:

2679 tbl 02

1. VIH = 2.6V for \overline{XI} input (commercial). VIH = 2.8V for \overline{XI} input (military).

2. 1.5V undershoots are allowed for 10ns once per cycle.

2679 tbl 03

2

Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS
may cause permanent damage to the device. This is a stress rating only
and functional operation of the device at these or any other conditions
above those indicated in the operational sections of this specification is not
implied. Exposure to absolute maximum rating conditions for extended
periods may affect reliabilty.

DC ELECTRICAL CHARACTERISTICS

(Commercial: $VCC = 5V \pm 10\%$, $TA = 0^{\circ}C$ to $+70^{\circ}C$; Industrial: $VCC = 5V \pm 10\%$, $TA = -40^{\circ}C$ to $+85^{\circ}C$; Military: $VCC = 5V \pm 10\%$, $TA = -55^{\circ}C$ to $+125^{\circ}C$)

		c	IDT7200L IDT7201L IDT7202L Com'l & Ind 15, 20, 25,	A ' ⁽¹⁾	tA			
Symbol	Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Unit
ILI ⁽²⁾	Input Leakage Current (Any Input)	-1	_	1	-10	_	10	μΑ
ILO ⁽³⁾	Output Leakage Current	-10	_	10	-10	_	10	μА
Vон	Output Logic "1" Voltage Ioн = -2mA	2.4	_	_	2.4	_	_	V
Vol	Output Logic "0" Voltage IoL = 8mA	_	_	0.4	_	_	0.4	V
ICC1 ^(4,5,6)	Active Power Supply Current	_	_	125	_	_	140	mA
ICC2 ^(4,6,7)	Standby Current (R=W=RS=FL/RT=VIH)	_	_	15	_	_	20	mA
ICC3(L) ^(4,6,7)	Power Down Current	_	_	0.5		_	0.9	mA

2679 tbl 04

		IDT7200L IDT7200L IDT7201LA IDT7201LA IDT7201LA IDT7202LA IDT720						
Symbol	Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Unit
ILI ⁽²⁾	Input Leakage Current (Any Input)	-1	_	1	-10	_	10	μА
ILO ⁽³⁾	Output Leakage Current	-10	_	10	-10	1	10	μΑ
Voн	Output Logic "1" Voltage IOH = -2mA	2.4	_	_	2.4	-	_	V
Vol	Output Logic "0" Voltage IoL = 8mA	1	_	0.4	_	1	0.4	V
ICC1 ^(4,5,6)	Active Power Supply Current	_	50	80	_	70	100	mA
ICC2 ^(4,6,7)	Standby Current ($\overline{R}=\overline{W}=\overline{RS}=\overline{FL}/\overline{RT}=VIH$)		5	8	_	8	15	mA
ICC3(L) ^(4,6,7)	Power Down Current	_	_	0.5	_	_	0.9	mA

NOTES:

- 2679 tbl 05
- 1. Industrial temperature range product for the 25 ns speed grade is available as a standard device. All other speed grades are available by special order.
- 2. Measurements with $0.4 \le Vin \le Vcc$.
- 3. $\overline{R} \ge VIH$, $0.4 \le VOUT \le VCC$.
- 4. Tested with outputs open (IOUT = 0).
- 5. RCLK and WCLK toggle at 20 MHz and data inputs switch at 10 MHz.
- 6. Icc measurements are made with outputs open.
- 7. All Inputs = Vcc 0.2V or GND + 0.2V, except RCLK and WCLK, which toggle at 20 MHz.

AC TEST CONDITIONS

Input Pulse Levels	GND to 3.0V
Input Rise/Fall Times	5ns
Input Timing Reference Levels	1.5V
Output Reference Levels	1.5V
Output Load	See Figure 1

AC ELECTRICAL CHARACTERISTICS(1)

(Commercial: $VCC = 5V \pm 10\%$, $TA = 0^{\circ}C$ to $+70^{\circ}C$; Industrial: $VCC = 5V \pm 10\%$, $TA = -40^{\circ}C$ to $+85^{\circ}C$; Military: $VCC = 5V \pm 10\%$, $TA = -55^{\circ}C$ to $+125^{\circ}C$)

Parameter	Ŭ	Torolar	al: $VCC = 5V \pm 10\%$, $IA = 0\%$ to $\pm 70\%$; industi	· · ·			1		·		1	itary		m'l	120 0)	
ts Shift Frequency — 50 — 40 — 33.3 — 25 — 25 — 22 — 25 — 30 — 35 — 40 — 45 — 14 Access Time — 12 — 15 — 20 — 25 — 30 — 35 — 40 — 40 — 40 — 40 — 40 — 40 — 40 — 40 — 40 — 40 — 40 — 40 — 40 — 40 — 40 — 40 — 5 — 5 — 5 — 5 — 5 — 5 — 5 — 5 — 5 — 5 — 5 — 5 — 5 — 5 — 5 — 5 — <th></th> <th></th> <th></th> <th>7200 7201</th> <th>)L12 LA12</th> <th>7200 7201</th> <th>L15 LA15</th> <th>7200 7201</th> <th>L20 LA20</th> <th>7200 7201</th> <th>L25 LA25</th> <th>720 7201</th> <th>0L30 LA30</th> <th colspan="2">_A30 7201LA35</th> <th></th>				7200 7201)L12 LA12	7200 7201	L15 LA15	7200 7201	L20 LA20	7200 7201	L25 LA25	720 7201	0L30 LA30	_A30 7201LA35		
tRC Read Cycle Time 20 25 30 35 40 45 -12 IA Access Time — 12 — 15 — 20 — 25 — 30 — 3 IRR Read Recovery Time 8 — 10		ool	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Unit
th Access Time — 12 — 15 — 20 — 25 — 30 — 3 IRR Read Read Recovery Time 8 — 10 — 15 — 5 <td>qı</td> <td>S</td> <td>Shift Frequency</td> <td>_</td> <td>50</td> <td>_</td> <td>40</td> <td>_</td> <td>33.3</td> <td>_</td> <td>28.5</td> <td>_</td> <td>25</td> <td>_</td> <td>22.2</td> <td>MHz</td>	qı	S	Shift Frequency	_	50	_	40	_	33.3	_	28.5	_	25	_	22.2	MHz
trik Read Recovery Time 8 — 10	/cl	R	Read Cycle Time	20	_	25	_	30	_	35	_	40	_	45	_	ns
tRPW Read Pulse Width ⁽³⁾ 12 15 20 25 30 35 1RLZ Read Pulse Low to Data Bus at Low Z ⁽⁴⁾ 3 - 5 -	Tir	Α	Access Time	_	12		15	_	20	_	25	_	30		35	ns
IRLZ Read Pulse Low to Data Bus at Low Z ⁽⁴⁾ 3 — 5 <td>ес</td> <td>R</td> <td>Read Recovery Time</td> <td>8</td> <td>_</td> <td>10</td> <td>_</td> <td>10</td> <td>_</td> <td>10</td> <td>_</td> <td>10</td> <td>_</td> <td>10</td> <td>_</td> <td>ns</td>	ес	R	Read Recovery Time	8	_	10	_	10	_	10	_	10	_	10	_	ns
twl.z Write Pulse High to Data Bus at Low Z ^(4,5) 3 - 5 -	ıls	R	Read Pulse Width ⁽³⁾	12	_	15	_	20	_	25	_	30	_	35	_	ns
tov Data Valid from Read Pulse High 5 5 5 5 5 5 5 5 - 5 - 5 - 5 - 5 - 5 - 5 - 5 - 5 - 5 - 5 - 5 - 5 - 5 - 2 3 3 4 0 4 0 1	ıls	R	Read Pulse Low to Data Bus at Low Z ⁽⁴⁾	3		5	_	5	_	5	_	5	_	5		ns
tRHZ Read Pulse High to Data Bus at High Z ⁽⁴⁾ — 12 — 15 — 18 — 20 — 2 twc Write Cycle Time 20 — 25 — 30 — 35 — 40 — 45 — twR Write Pulse Width(3) 12 — 15 — 20 — 25 — 30 — 35 — 40 — 40 — 40 — 40 — 10 —	ıls	٧	Write Pulse High to Data Bus at Low Z ^(4,5)	3	_	5	_	5	_	5	_	5	_	10	_	ns
twc Write Cycle Time 20 — 25 — 30 — 35 — 40 — 45 — twpw Write Pulse Width ⁽³⁾ 12 — 15 — 20 — 25 — 30 — 35 — 40 — 45 — 10 —	lid	D	Data Valid from Read Pulse High	5	_	5	_	5	-	5		5	_	5	_	ns
twpw Write Pulse Width ⁽³⁾ 12 15 20 25 30 35 - twr Write Recovery Time 8 10 <td>ıls</td> <td>R</td> <td>Read Pulse High to Data Bus at High Z⁽⁴⁾</td> <td>_</td> <td>12</td> <td>_</td> <td>15</td> <td>_</td> <td>15</td> <td>_</td> <td>18</td> <td>_</td> <td>20</td> <td></td> <td>20</td> <td>ns</td>	ıls	R	Read Pulse High to Data Bus at High Z ⁽⁴⁾	_	12	_	15	_	15	_	18	_	20		20	ns
twr Write Recovery Time 8 — 10 — 0 — 10 — 10 <td>/cl</td> <td>V</td> <td>Write Cycle Time</td> <td>20</td> <td>_</td> <td>25</td> <td>_</td> <td>30</td> <td>_</td> <td>35</td> <td>_</td> <td>40</td> <td>_</td> <td>45</td> <td>_</td> <td>ns</td>	/cl	V	Write Cycle Time	20	_	25	_	30	_	35	_	40	_	45	_	ns
tos Data Set-up Time 9 11 12 15 18 18 -18 -10 10 -0	ıls	V	Write Pulse Width ⁽³⁾	12	_	15		20	_	25	_	30	_	35	_	ns
tDH Data Hold Time 0 —	eco	V	Write Recovery Time	8	_	10	_	10	_	10	_	10	_	10	_	ns
trisc Reset Cycle Time 20 25 30 35 40 45	t-ı	D	Data Set-up Time	9	_	11	_	12	_	15	_	18	_	18	_	ns
trss Reset Pulse Width ⁽³⁾ 12 — 15 — 20 — 25 — 30 — 35 — trss Reset Set-up Time ⁽⁴⁾ 12 — 15 — 20 — 25 — 30 — 35 — trss Reset Recovery Time 8 — 10	ld	D	Data Hold Time	0	_	0	_	0	ı	0	1	0		0	_	ns
trss Reset Set-up Time ⁽⁴⁾ 12 — 15 — 20 — 25 — 30 — 35 — trss Reset Recovery Time 8 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 40 — 45 — 10 — 10 — 10 — 10 — 15 — 20 — 25 — 30 — 35 — 40 — 42 — 12 — 15 — 20 — 25 — 30 — 35 — 40 — 12 — 10 — 10 — 10 — 10 — 10 — 10	yc	R	Reset Cycle Time	20	_	25	_	30	_	35	_	40		45	_	ns
RRSR Reset Recovery Time 8 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 40 — 45 — 10 — 12 — 15 — 20 — 25 — 30 — 35 — 40 — 45 — 10 — 10 — 10 — 10 — 35 — 40 — 35 — 40 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — 25	uls	R	Reset Pulse Width ⁽³⁾	12	_	15	_	20	-	25		30		35	_	ns
trtc Retransmit Cycle Time 20 — 25 — 30 — 35 — 40 — 45 — trt Retransmit Pulse Width ⁽³⁾ 12 — 15 — 20 — 25 — 30 — 35 — trt Retransmit Set-up Time ⁽⁴⁾ 12 — 15 — 20 — 25 — 30 — 35 — trt Retransmit Recovery Time 8 — 10 —	et-	R	Reset Set-up Time ⁽⁴⁾	12	_	15	_	20	_	25	_	30	_	35	_	ns
trt Retransmit Pulse Width ⁽³⁾ 12 — 15 — 20 — 25 — 30 — 35 — trts Retransmit Set-up Time ⁽⁴⁾ 12 — 15 — 20 — 25 — 30 — 35 — trt Retransmit Recovery Time 8 — 10 —	ec	R	Reset Recovery Time	8	_	10	_	10	_	10		10	_	10	_	ns
trts Retransmit Set-up Time ⁽⁴⁾ 12 — 15 — 20 — 25 — 30 — 35 — trtr Retransmit Recovery Time 8 — 10 — 20 — 25 — 30 — 35 — 40 — 41 11 — 12 — 15 —	mi	R	Retransmit Cycle Time	20	_	25	_	30	_	35	_	40	_	45	_	ns
trtr Retransmit Recovery Time 8 — 10 — 40 — 40 — 40 — 40 — 40 — 40 — 40 — 10 — 11 — 12 — 15 — 20 — 25 — 30 — 35 — 40	mi	R	Retransmit Pulse Width ⁽³⁾	12	_	15	_	20	_	25	_	30	_	35	_	ns
tEFL Reset to Empty Flag Low — 12 — 25 — 30 — 35 — 40 — 4 thff, FFH Reset to Half-Full and Full Flag High — 17 — 25 — 30 — 35 — 40 — 4 tree Retransmit Low to Flags Valid — 20 — 25 — 30 — 35 — 40 — 4 tree Read Low to Flags Valid — 20 — 25 — 30 — 35 — 40 — 4 tree Read Low to Empty Flag Low — 12 — 15 — 20 — 25 — 30 — 35 — 40 — 4 tree Read Pulse Width after EF High 12 — 15 — 20 — 25 — 30 — 35 — twee Write High to Empty Flag High — 12 — 15 — 20 —	mi	R	Retransmit Set-up Time ⁽⁴⁾	12	_	15	_	20	_	25	_	30	_	35	_	ns
thffh,FFh Reset to Half-Full and Full Flag High — 17 — 25 — 30 — 35 — 40 — 4 treff Retransmit Low to Flags Valid — 20 — 25 — 30 — 35 — 40 — 4 treff Read Low to Empty Flag Low — 12 — 15 — 20 — 25 — 30 — 3 treff Read High to Full Flag High — 14 — 15 — 20 — 25 — 30 — 35 — 40 — 3 treff Read Pulse Width after Feligh 12 — 15 — 20 — 25 — 30 — 35 — twee Write High to Empty Flag High — 12 — 15 — 20 — 25 — 30 — 35 — 40 — 4 4 4 — 15 — 20 — 25	mi	R	Retransmit Recovery Time	8	_	10	_	10	_	10	_	10	_	10	_	ns
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tree Read Low to Empty Flag Low — 12 — 15 — 20 — 25 — 30 — 3 tree Read High to Full Flag High — 14 — 15 — 20 — 25 — 30 — 35 twee Read Pulse Width after EF High 12 — 15 — 20 — 25 — 30 — 35 — twee Write High to Empty Flag High — 12 — 15 — 20 — 25 — 30 — 35 — twee Write Low to Full Flag Low — 14 — 15 — 20 — 25 — 30 — 35 twhe Write Low to Half-Full Flag Low — 17 — 25 — 30 — 35 — 40 — twhe Write Pulse Width after FF High — 17) 	FH R	Reset to Half-Full and Full Flag High	_	17		25	_	30	_	35	_	40		45	ns
tRFF Read High to Full Flag High — 14 — 15 — 20 — 25 — 30 — 3 tRPE Read Pulse Width after FF High 12 — 15 — 20 — 25 — 30 — 35 — tWEF Write High to Empty Flag High — 12 — 15 — 20 — 25 — 30 — 3 tWFF Write Low to Full Flag Low — 14 — 15 — 20 — 25 — 30 — 3 tWHF Write Low to Half-Full Flag Low — 17 — 25 — 30 — 35 — 40 — 4 tRHF Read High to Half-Full Flag High — 17 — 25 — 30 — 35 — 40 — 4 tWPF Write Pulse Width after FF High 12 — <td>mi</td> <td>R</td> <td>Retransmit Low to Flags Valid</td> <td>_</td> <td>20</td> <td></td> <td>25</td> <td>_</td> <td>30</td> <td>_</td> <td>35</td> <td>_</td> <td>40</td> <td>-</td> <td>45</td> <td>ns</td>	mi	R	Retransmit Low to Flags Valid	_	20		25	_	30	_	35	_	40	-	45	ns
trpe Read Pulse Width after EF High 12 — 15 — 20 — 25 — 30 — 35 — twef Write High to Empty Flag High — 12 — 15 — 20 — 25 — 30 — 3 twef Write Low to Full Flag Low — 14 — 15 — 20 — 25 — 30 — 3 twhf Write Low to Half-Full Flag Low — 17 — 25 — 30 — 35 — 40 — 4 treat Read High to Half-Full Flag High — 17 — 25 — 30 — 35 — 40 — twpf Write Pulse Width after FF High 12 — 15 — 20 — 25 — 30 — 35 —	w	R	Read Low to Empty Flag Low	_	12	_	15	_	20		25	_	30	I	30	ns
tWEF Write High to Empty Flag High — 12 — 15 — 20 — 25 — 30 — 3 tWFF Write Low to Full Flag Low — 14 — 15 — 20 — 25 — 30 — 3 tWHF Write Low to Half-Full Flag Low — 17 — 25 — 30 — 35 — 40 — 4 tRHF Read High to Half-Full Flag High — 17 — 25 — 30 — 35 — 40 — 4 tWPF Write Pulse Width after FF High 12 — 15 — 20 — 25 — 30 — 35 —	gh	R	Read High to Full Flag High	_	14	_	15	_	20	_	25	_	30	-	30	ns
tWFF Write Low to Full Flag Low — 14 — 15 — 20 — 25 — 30 — 3 tWHF Write Low to Half-Full Flag Low — 17 — 25 — 30 — 35 — 40 — 4 tRHF Read High to Half-Full Flag High — 17 — 25 — 30 — 35 — 40 — 4 tWPF Write Pulse Width after FF High 12 — 15 — 20 — 25 — 30 — 35 —	ıls	R	Read Pulse Width after EF High	12	_	15	_	20	_	25	_	30	_	35	_	ns
twhf Write Low to Half-Full Flag Low — 17 — 25 — 30 — 40 — 4 tRHF Read High to Half-Full Flag High — 17 — 25 — 30 — 35 — 40 — 4 twpr Write Pulse Width after FF High 12 — 15 — 20 — 25 — 30 — 35 —	gh	٧	Write High to Empty Flag High	_	12	_	15	_	20		25	_	30	I	30	ns
tRHF Read High to Half-Full Flag High — 17 — 25 — 30 — 35 — 40 — 4 twpr Write Pulse Width after FF High 12 — 15 — 20 — 25 — 30 — 35 —	w	٧	Write Low to Full Flag Low	_	14	_	15	_	20	_	25	_	30	_	30	ns
twpf Write Pulse Width after FF High 12 — 15 — 20 — 25 — 30 — 35 —	w	٧	Write Low to Half-Full Flag Low	_	17		25	_	30	_	35	_	40	_	45	ns
 	gh	R	Read High to Half-Full Flag High	_	17	_	25	_	30	_	35	_	40	_	45	ns
	ıls	٧	Write Pulse Width after FF High	12	_	15	_	20	_	25	_	30	_	35	_	ns
txoL Read/Write to XO Low — 12 — 15 — 20 — 25 — 30 — 3	rit	R	Read/Write to XO Low	_	12	_	15	_	20	_	25	_	30	_	35	ns
				_	12	_	15	_		_		_	30	_	35	ns
txi XI Pulse Width ⁽³⁾ 12 — 15 — 20 — 25 — 30 — 35 —				12	_	15	_	20	_	25	_	30	_	35	_	ns
txir XI Recovery Time 8 - 10 - 10 - 10 - 10 -	ve	X	XI Recovery Time	8		10	_	10		10	_	10		10		ns
txis XI Set-up Time 8 - 10 - 10 - 10 - 10 -			-				_		_	10					_	ns

NOTES

- 1. Timings referenced as in AC Test Conditions.
- 2. Industrial temperature range is available by special order for speed grades faster than 25ns.
- 3. Pulse widths less than minimum value are not allowed.
- 4. Values guaranteed by design, not currently tested.
- 5. Only applies to read data flow-through mode.

AC ELECTRICAL CHARACTERISTICS⁽¹⁾ (Continued)

(Commercial: $VCC = 5V \pm 10\%$, $TA = 0^{\circ}C$ to $+70^{\circ}C$; Industrial: $VCC = 5V \pm 10\%$, $TA = -40^{\circ}C$ to $+85^{\circ}C$; Military: $VCC = 5V \pm 10\%$, $TA = -55^{\circ}C$ to $+125^{\circ}C$)

		Mili	tary	Com'	I & Mil.		<u> </u>	Milit	ary ⁽²⁾			
			L40 LA40 LA40	7200L50 7201LA50 7202LA50		7201	0L65 LA65 LA65	7200 7201 7202)L80 LA80	7201L	L120 _A120 _A120	
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Unit
ts	Shift Frequency	_	20	_	15	_	12.5	_	10	_	7	MHz
trc	Read Cycle Time	50	_	65	_	80	_	100	_	140	_	ns
tA	Access Time	_	40	_	50	_	65	_	80	_	120	ns
trr	Read Recovery Time	10	_	15	_	15	_	20	_	20	_	ns
trpw	Read Pulse Width ⁽³⁾	40	_	50	_	65	_	80	_	120	_	ns
trlz	Read Pulse Low to Data Bus at Low Z ⁽⁴⁾	5	_	10	_	10	_	10	_	10	_	ns
twlz	Write Pulse High to Data Bus at Low $Z^{(4, 5)}$	10	_	15	_	15	_	20	_	20	_	ns
tDV	Data Valid from Read Pulse High	5	_	5	_	5	_	5	_	5	_	ns
trhz	Read Pulse High to Data Bus at High Z ⁽⁴⁾	_	25	_	30	_	30	_	30	_	35	ns
twc	Write Cycle Time	50	_	65	_	80	_	100	_	140	_	ns
twpw	Write Pulse Width ⁽³⁾	40	_	50	_	65	_	80	_	120	_	ns
twr	Write Recovery Time	10	_	15	_	15	_	20	_	20	_	ns
tDS	Data Set-up Time	20	_	30	_	30	_	40	_	40	_	ns
tDH	Data Hold Time	0	_	5	_	10	_	10	_	10	_	ns
trsc	Reset Cycle Time	50	_	65	_	80	_	100	_	140	_	ns
trs	Reset Pulse Width ⁽³⁾	40	_	50	_	65	_	80	_	120	_	ns
trss	Reset Set-up Time ⁽⁴⁾	40	_	50	_	65	_	80	_	120	_	ns
trsr	Reset Recovery Time	10	_	15	_	15	_	20	_	20	-	ns
trtc	Retransmit Cycle Time	50	_	65	_	80	_	100	_	140	_	ns
trt	Retransmit Pulse Width ⁽³⁾	40	_	50	_	65	_	80	_	120	_	ns
trts	Retransmit Set-up Time ⁽⁴⁾	40	_	50	_	65	_	80	_	120	_	ns
trtr	Retransmit Recovery Time	10	_	15	_	15	_	20	_	20	_	ns
tEFL	Reset to Empty Flag Low	_	50	_	65	_	80	_	100	_	140	ns
thfh,ffh	Reset to Half-Full and Full Flag High	_	50	_	65	_	80	_	100	_	140	ns
trtf	Retransmit Low to Flags Valid		50	_	65	_	80	_	100	_	140	ns
tref	Read Low to Empty Flag Low	1	30	_	45	_	60	_	60	_	60	ns
trff	Read High to Full Flag High	_	35	_	45	_	60	_	60	_	60	ns
trpe	Read Pulse Width after EF High	40	_	50	_	65	_	80	_	120	_	ns
tweF	Write High to Empty Flag High	_	35	_	45	_	60	_	60	_	60	ns
twff	Write Low to Full Flag Low	_	35	_	45	_	60	_	60	_	60	ns
twhf	Write Low to Half-Full Flag Low		50	_	65	_	80	_	100	_	140	ns
trhf	Read High to Half-Full Flag High	_	50		65	_	80		100		140	ns
twpf	Write Pulse Width after FF High	40	_	50	_	65	_	80	_	120	_	ns
txoL	Read/Write to XO Low		40	_	50	_	65	_	80	_	120	ns
tхон	Read/Write to XO High	_	40	_	50	_	65	_	80	_	120	ns
txı	XI Pulse Width ⁽³⁾	40	_	50	_	65	_	80	_	120	_	ns
txir	XI Recovery Time	10	_	10	_	10	_	10	_	10	_	ns
txis	XI Set-up Time	10	_	15	_	15	_	15	_	15	_	ns

NOTES:

- 1. Timings referenced as in AC Test Conditions
- 2. Speed grades 65, 80 and 120 not available in the CERPACK
- 3. Pulse widths less than minimum value are not allowed.
- 4. Values guaranteed by design, not currently tested.
- 5. Only applies to read data flow-through mode.

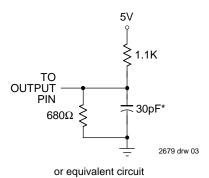


Figure 1. Output Load

* Includes scope and jig capacitances.

SIGNAL DESCRIPTIONS

INPUTS:

DATA IN $(D_0 - D_8)$

Data inputs for 9-bit wide data.

CONTROLS:

RESET (RS)

Reset is accomplished whenever the Reset (\overline{RS}) input is taken to a low state. During reset, both internal read and write pointers are set to the first location. A reset is required after power up before a write operation can take place. Both the Read Enable (\overline{R}) and Write Enable (\overline{W}) inputs must be in the high state during the window shown in Figure 2, (i.e., trss before the rising edge of \overline{RS}) and should not change until trsr after the rising edge of \overline{RS} . Half-Full Flag (\overline{HF}) will be reset to high after Reset (\overline{RS}) .

WRITE ENABLE (\overline{W})

A write cycle is initiated on the falling edge of this input if the Full Flag ($\overline{\text{FF}}$) is not set. Data set-up and hold times must be adhered to with respect to the rising edge of the Write Enable ($\overline{\text{W}}$). Data is stored in the RAM array sequentially and independently of any on-going read operation.

After half of the memory is filled and at the falling edge of the next write operation, the Half-Full Flag ($\overline{\text{HF}}$) will be set to low and will remain set until the difference between the write pointer and read pointer is less than or equal to one half of the total memory of the device. The Half-Full Flag ($\overline{\text{HF}}$) is then reset by the rising edge of the read operation.

To prevent data overflow, the Full Flag (FF) will go low, inhibiting further write operations. Upon the completion of a valid read operation, the Full Flag (FF) will go high after tRFF, allowing a valid write to begin. When the FIFO is full, the internal write pointer is blocked from \overline{W} , so external changes in \overline{W} will not affect the FIFO when it is full.

READ ENABLE (\overline{R})

A read cycle is initiated on the falling edge of the Read Enable (\overline{R}) provided the Empty Flag (\overline{EF}) is not set. The data is accessed on a First-In/First-Out basis, independent of any

ongoing write operations. After Read Enable (\overline{R}) goes high, the Data Outputs (Q_0-Q_8) will return to a high impedance condition until the next Read operation. When all data has been read from the FIFO, the Empty Flag (\overline{EF}) will go low, allowing the "final" read cycle but inhibiting further read operations with the data outputs remaining in a high impedance state. Once a valid write operation has been accomplished, the Empty Flag (\overline{EF}) will go high after tWEF and a valid Read can then begin. When the FIFO is empty, the internal read pointer is blocked from \overline{R} so external changes in \overline{R} will not affect the FIFO when it is empty.

FIRST LOAD/RETRANSMIT (FL/RT)

This is a dual-purpose input. In the Depth Expansion Mode, this pin is grounded to indicate that it is the first loaded (see Operating Modes). In the Single Device Mode, this pin acts as the restransmit input. The Single Device Mode is initiated by grounding the Expansion In (\overline{XI}) .

The IDT7200/7201A/7202A can be made to retransmit data when the Retransmit Enable control (\overline{RT}) input is pulsed low. A retransmit operation will set the internal read pointer to the first location and will not affect the write pointer. Read Enable (\overline{R}) and Write Enable (\overline{W}) must be in the high state during retransmit. This feature is useful when less than 256/512/1,024 writes are performed between resets. The retransmit feature is not compatible with the Depth Expansion Mode and will affect the Half-Full Flag (\overline{HF}) , depending on the relative locations of the read and write pointers.

EXPANSION IN (XI)

This input is a dual-purpose pin. Expansion In (\overline{XI}) is grounded to indicate an operation in the single device mode. Expansion In (\overline{XI}) is connected to Expansion Out (\overline{XO}) of the previous device in the Depth Expansion or Daisy Chain Mode.

OUTPUTS:

FULL FLAG (FF)

The Full Flag (FF) will go low, inhibiting further write operation, when the write pointer is one location less than the read pointer, indicating that the device is full. If the read pointer is not moved after Reset (RS), the Full-Flag (FF) will go low after 256 writes for IDT7200, 512 writes for the IDT7201A and 1,024 writes for the IDT7202A.

EMPTY FLAG (EF)

The Empty Flag $(\overline{\text{EF}})$ will go low, inhibiting further read operations, when the read pointer is equal to the write pointer, indicating that the device is empty.

EXPANSION OUT/HALF-FULL FLAG (XO/HF)

This is a dual-purpose output. In the single device mode, when Expansion In (\overline{XI}) is grounded, this output acts as an indication of a half-full memory.

After half of the memory is filled and at the falling edge of the next write operation, the Half-Full Flag (\overline{HF}) will be set low and will remain set until the difference between the write

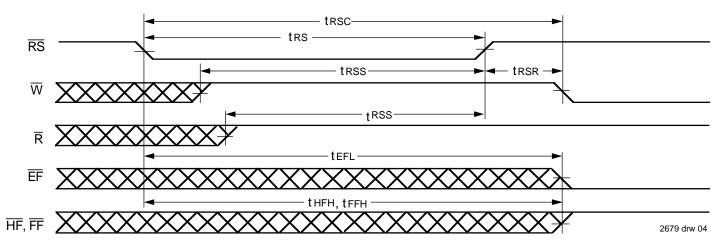
pointer and read pointer is less than or equal to one half of the total memory of the device. The Half-Full Flag (\overline{HF}) is then reset by using rising edge of the read operation.

In the Depth Expansion Mode, Expansion In (\overline{XI}) is connected to Expansion Out (\overline{XO}) of the previous device. This output acts as a signal to the next device in the Daisy Chain

by providing a pulse to the next device when the previous device reaches the last location of memory.

DATA OUTPUTS (Q0 - Q8)

Data outputs for 9-bit wide data. This data is in a high impedance condition whenever Read (\overline{R}) is in a high state.



NOTES:

- 1. $\overline{\text{EF}}$, $\overline{\text{FF}}$, $\overline{\text{HF}}$ may change status during Reset, but flags will be valid at trsc.
- 2. \overline{W} and $\overline{R} = V_{IH}$ around the rising edge of \overline{RS} .

Figure 2. Reset

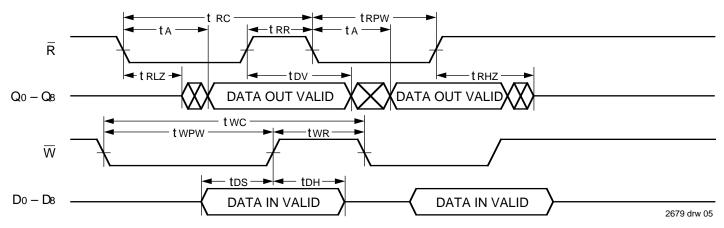


Figure 3. Asynchronous Write and Read Operation

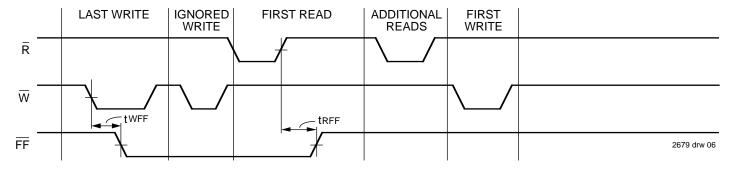


Figure 4. Full Flag From Last Write to First Read

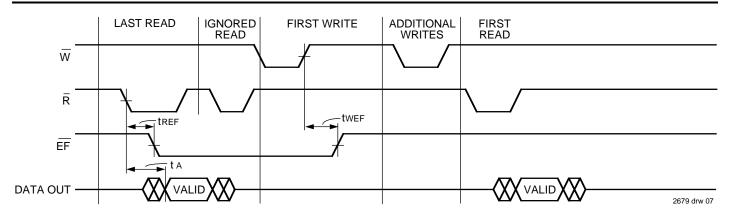


Figure 5. Empty Flag From Last Read to First Write

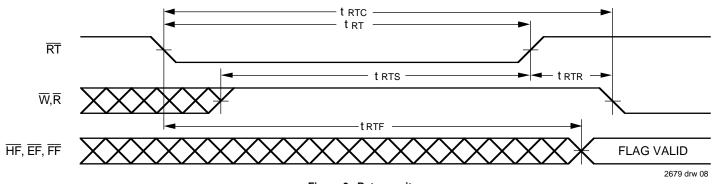


Figure 6. Retransmit

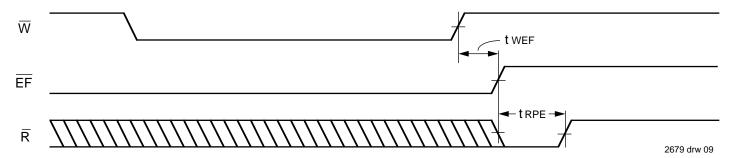


Figure 7. Minimum Timing for an Empty Flag Coincident Read Pulse

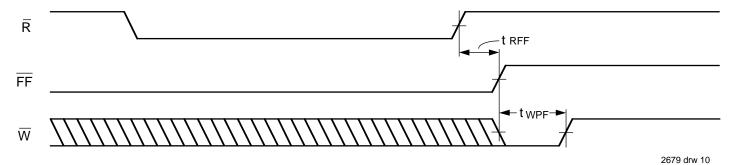


Figure 8. Minimum Timing for an Full Flag Coincident Write Pulse

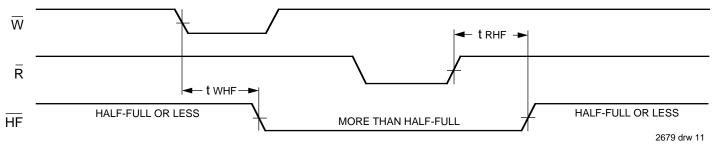


Figure 9. Half-Full Flag Timing

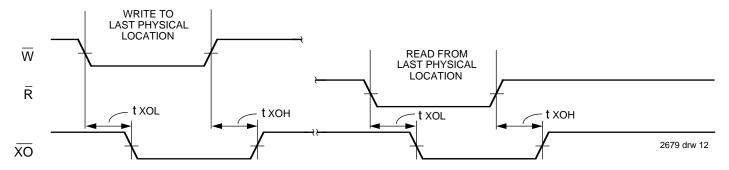


Figure 10. Expansion Out

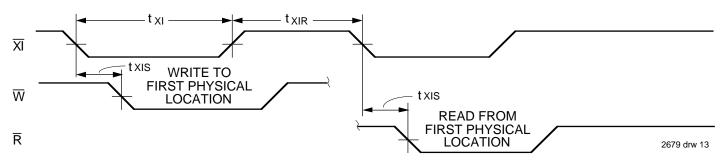


Figure 11. Expansion In

OPERATING MODES:

Care must be taken to assure that the appropriate flag is monitored by each system (i.e. \overline{FF} is monitored on the device where \overline{W} is used; \overline{EF} is monitored on the device where \overline{R} is used). For additional information, refer to Tech Note 8: *Operating FIFOs on Full and Empty Boundary Conditions* and Tech Note 6: *Designing with FIFOs.*

Single Device Mode

A single IDT7200/7201A/7202A may be used when the application requirements are for 256/512/1,024 words or less. These devices are in a Single Device Configuration when the Expansion In (\overline{XI}) control input is grounded (see Figure 12).

Depth Expansion

The IDT7200/7201A/7202A can easily be adapted to applications when the requirements are for greater than 256/512/1,024 words. Figure 14 demonstrates Depth Expansion using three IDT7200/7201A/7202As. Any depth can be attained by

adding additional IDT7200/7201A/7202As. These FIFOs operate in the Depth Expansion mode when the following conditions are met:

- The first device must be designated by grounding the First Load (FL) control input.
- 2. All other devices must have \overline{FL} in the high state.
- The Expansion Out (XO) pin of each device must be tied to the Expansion In (XI) pin of the next device. See Figure 14.
- 4. External logic is needed to generate a composite Full Flag (FF) and Empty Flag (EF). This requires the ORing of all EFs and ORing of all FFs (i.e. all must be set to generate the correct composite FF or EF). See Figure 14.
- 5. The Retransmit (RT) function and Half-Full Flag (HF) are not available in the Depth Expansion Mode.

For additional information, refer to Tech Note 9: *Cascading FIFOs or FIFO Modules*.

USAGE MODES:

Width Expansion

Word width may be increased simply by connecting the corresponding input control signals of multiple devices. Status flags (\overline{EF} , \overline{FF} and \overline{HF}) can be detected from any one device. Figure 13 demonstrates an 18-bit word width by using two IDT7200/7201A/7202As. Any word width can be attained by adding additional IDT7200/7201A/7202As (Figure 13).

Bidirectional Operation

Applications which require data buffering between two systems (each system capable of Read and Write operations) can be achieved by pairing IDT7200/7201A/7202As as shown in Figure 16. Both Depth Expansion and Width Expansion may be used in this mode.

Data Flow-Through

Two types of flow-through modes are permitted, a read flow-through and write flow-through mode. For the read flow-through mode (Figure 17), the FIFO permits a reading of a

single word after writing one word of data into an empty FIFO. The data is enabled on the bus in (twEF + tA) ns after the rising edge of \overline{W} , called the first write edge, and it remains on the bus until the \overline{R} line is raised from low-to-high, after which the bus would go into a three-state mode after tRHz ns. The \overline{EF} line would have a pulse showing temporary deassertion and then would be asserted.

In the write flow-through mode (Figure 18), the FIFO permits the writing of a single word of data immediately after reading one word of data from a full FIFO. The \overline{R} line causes the \overline{FF} to be deasserted but the \overline{W} line being low causes it to be asserted again in anticipation of a new data word. On the rising edge of \overline{W} , the new word is loaded in the FIFO. The \overline{W} line must be toggled when \overline{FF} is not asserted to write new data in the FIFO and to increment the write pointer.

Compound Expansion

The two expansion techniques described above can be applied together in a straightforward manner to achieve large FIFO arrays (see Figure 15).

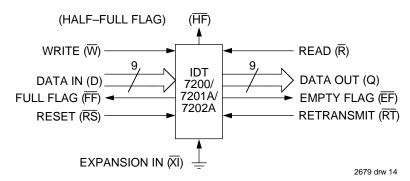


Figure 12. Block Diagram of Single 256 x 9, 512 x 9, 1,024 x 9 FIFO

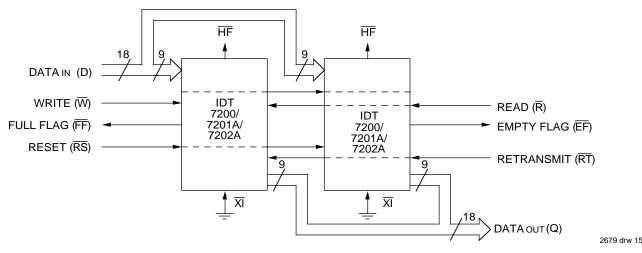


Figure 13. Block Diagram of 256 x 18, 512 x 18, 1,024 x 18 FIFO Memory Used in Width Expansion Mode

TABLE I—RESET AND RETRANSMIT

Single Device Configuration/Width Expansion Mode

		Inputs		Interna	I Status	Outputs		
Mode	Mode \overline{RS} \overline{RT} \overline{XI} Re		Read Pointer	Write Pointer	ĒF	FF	ĦF	
Reset	0	Х	0	Location Zero	Location Zero	0	1	1
Retransmit	1	0	0	Location Zero	Unchanged	Х	Х	Х
Read/Write	1	1	0	Increment ⁽¹⁾	Increment ⁽¹⁾	Х	Х	Х

NOTE:

2679 tbl 09

TABLE II—RESET AND FIRST LOAD TRUTH TABLE

Depth Expansion/Compound Expansion Mode

		Inputs		Interna	I Status	Outputs		
Mode	RS	FL	ΧĪ	Read Pointer	Write Pointer	ĒĒ	FF	
Reset First Device	0	0	(1)	Location Zero	Location Zero	0	1	
Reset All Other Devices	0	1	(1)	Location Zero	Location Zero	0	1	
Read/Write	1	Х	(1)	Х	X	Х	Х	

NOTE:

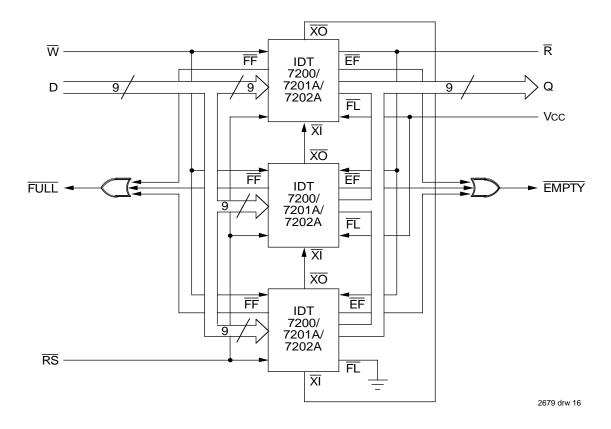
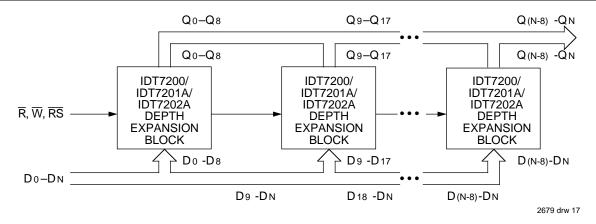


Figure 14. Block Diagram of 768 x 9, 1,536 x 9, 3,072 x 9 FIFO Memory (Depth Expansion)

^{1.} Pointer will increment if flag is High.

^{1.} \overline{XI} is connected to \overline{XO} of previous device. See Figure 14. \overline{RS} = Reset Input, $\overline{FL/RT}$ = First Load/Retransmit, \overline{EF} = Empty Flag Output, \overline{FF} = Flag Full Output, \overline{XI} = Expansion Input, \overline{HF} = Half-Full Flag Output



NOTES:

- 1. For depth expsansion block see section on Depth Expansion and Figure 14.
- 2. For Flag detection see section on Width Expansion and Figure 13.

Figure 15. Compound FIFO Expansion

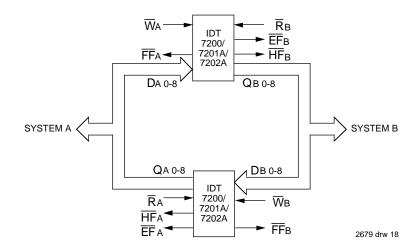


Figure 16. Bidirectional FIFO Mode

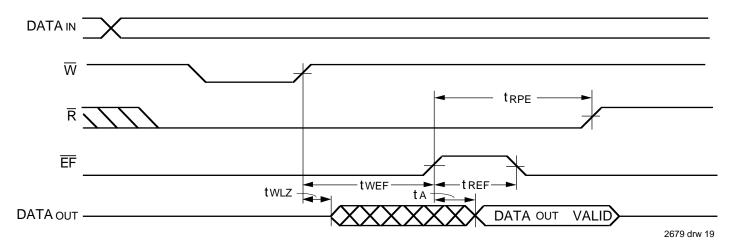


Figure 17. Read Data Flow-Through Mode

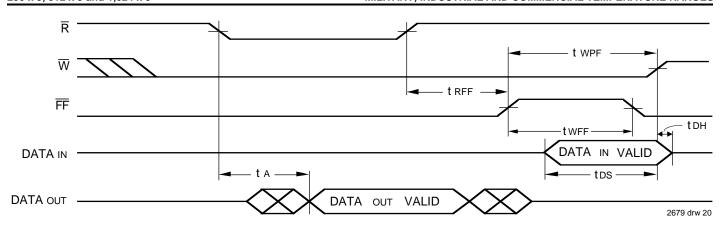
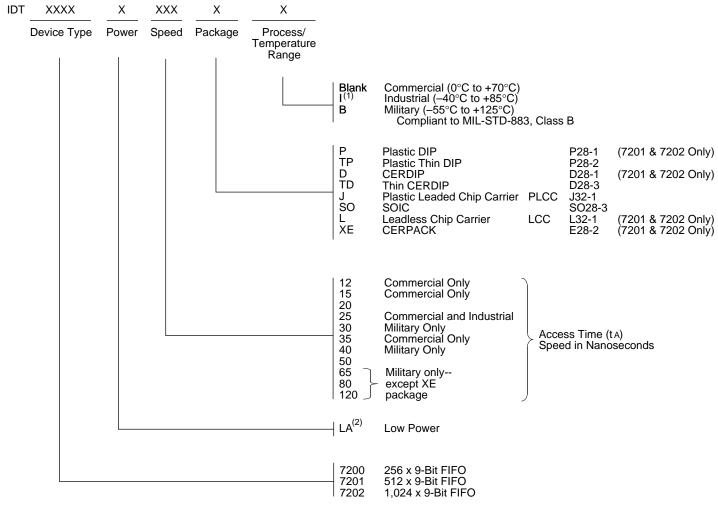


Figure 18. Write Data Flow-Through Mode

ORDERING INFORMATION



2679 drw 21

NOTES:

- 1. Industrial temperature range is available for plastic packages by special order for speed grades faster than 25 ns.
- 2. "A" to be included for 7201 and 7202 ordering part number.